Requirements for Soldering Fluxes

A standard developed by the Flux Specifications Task Group (5-24a) of the Assembly and Joining Processes Committee (5-20) of IPC

Users of this publication are encouraged to participate in the development of future revisions.

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Requirements for Soldering Fluxes

1 SCOPE AND DESIGNATION

1.1 Scope This standard prescribes general requirements for the classification and characterization of fluxes for high quality solder interconnections. This standard may be used for quality control and procurement purposes.

1.2 Purpose The purpose of this standard is to classify and characterize tin/lead and lead-free soldering flux materials for use in electronic metallurgical interconnections for printed circuit board assembly. Soldering flux materials include the following: liquid flux, paste flux, solder paste, solder cream, and flux-coated and flux-cored solder wires and preforms. It is not the intent of this standard to exclude any acceptable flux or soldering material; however, these materials must produce the desired electrical and metallurgical interconnection.

The requirements for fluxes are defined in general terms for standard classification. Appendix B has additional information that will help users understand some of the requirements of this standard. In practice, where more stringent requirements are necessary or other manufacturing processes are used, the user shall define these as additional requirements.

1.3 Designation For ordering purposes and designation by other specifications, the following flux identification system shall be used (see Table 1-1).

1.4 Interpretation “Shall” The imperative form of the verb is used throughout this standard whenever a requirement is intended to express a provision that is mandatory. Deviation from a “shall” requirement may be considered if sufficient information is supplied to justify the exception.

### Table 1-1 Flux Identification System

<table>
<thead>
<tr>
<th>Flux Composition</th>
<th>Flux/Flux Residue Activity Levels</th>
<th>% Halide(^1) (by weight)</th>
<th>Flux Type(^2)</th>
<th>Flux Designator</th>
</tr>
</thead>
<tbody>
<tr>
<td>Rosin (RO)</td>
<td>Low</td>
<td>&lt;0.05%</td>
<td>L0</td>
<td>ROL0</td>
</tr>
<tr>
<td></td>
<td></td>
<td>&lt;0.5%</td>
<td>L1</td>
<td>ROL1</td>
</tr>
<tr>
<td></td>
<td>Moderate</td>
<td>&lt;0.05%</td>
<td>M0</td>
<td>ROM0</td>
</tr>
<tr>
<td></td>
<td></td>
<td>0.5-2.0%</td>
<td>M1</td>
<td>ROM1</td>
</tr>
<tr>
<td></td>
<td>High</td>
<td>&lt;0.05%</td>
<td>H0</td>
<td>ROH0</td>
</tr>
<tr>
<td></td>
<td></td>
<td>&gt;2.0%</td>
<td>H1</td>
<td>ROH1</td>
</tr>
<tr>
<td>Resin (RE)</td>
<td>Low</td>
<td>&lt;0.05%</td>
<td>L0</td>
<td>REL0</td>
</tr>
<tr>
<td></td>
<td></td>
<td>&lt;0.5%</td>
<td>L1</td>
<td>REL1</td>
</tr>
<tr>
<td></td>
<td>Moderate</td>
<td>&lt;0.05%</td>
<td>M0</td>
<td>REM0</td>
</tr>
<tr>
<td></td>
<td></td>
<td>0.5-2.0%</td>
<td>M1</td>
<td>REM1</td>
</tr>
<tr>
<td></td>
<td>High</td>
<td>&lt;0.05%</td>
<td>H0</td>
<td>REH0</td>
</tr>
<tr>
<td></td>
<td></td>
<td>&gt;2.0%</td>
<td>H1</td>
<td>REH1</td>
</tr>
<tr>
<td>Organic (OR)</td>
<td>Low</td>
<td>&lt;0.05%</td>
<td>L0</td>
<td>ORL0</td>
</tr>
<tr>
<td></td>
<td></td>
<td>&lt;0.5%</td>
<td>L1</td>
<td>ORL1</td>
</tr>
<tr>
<td></td>
<td>Moderate</td>
<td>&lt;0.05%</td>
<td>M0</td>
<td>ORM0</td>
</tr>
<tr>
<td></td>
<td></td>
<td>0.5-2.0%</td>
<td>M1</td>
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<tr>
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<td>High</td>
<td>&lt;0.05%</td>
<td>H0</td>
<td>ORH0</td>
</tr>
<tr>
<td></td>
<td></td>
<td>&gt;2.0%</td>
<td>H1</td>
<td>ORH1</td>
</tr>
<tr>
<td>Inorganic (IN)</td>
<td>Low</td>
<td>&lt;0.05%</td>
<td>L0</td>
<td>INL0</td>
</tr>
<tr>
<td></td>
<td></td>
<td>&lt;0.5%</td>
<td>L1</td>
<td>INL1</td>
</tr>
<tr>
<td></td>
<td>Moderate</td>
<td>&lt;0.05%</td>
<td>M0</td>
<td>INM0</td>
</tr>
<tr>
<td></td>
<td></td>
<td>0.5-2.0%</td>
<td>M1</td>
<td>INM1</td>
</tr>
<tr>
<td></td>
<td>High</td>
<td>&lt;0.05%</td>
<td>H0</td>
<td>INH0</td>
</tr>
<tr>
<td></td>
<td></td>
<td>&gt;2.0%</td>
<td>H1</td>
<td>INH1</td>
</tr>
</tbody>
</table>

1. Halide measuring <0.05% by weight in flux solids and may be known as halide-free. This method determines the amount of ionic halide present (see Appendix B-10).

2. The 0 and 1 indicate the absence or presence of halides, respectively. See paragraph 3.3.1.2.2 for flux type nomenclature.